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| Form 1949 (Modified) Information Disclosure Statement By Applicant (Use Several Sheets if Necessary) | Attorney Docket No: U.S. ARTCP031 10/074,517 Applicant: TEMPLETON et al. Filing Date: Group: February 2, 2002 2812 |
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Foreign Patent or Published Foreign Patent Application

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| Examiner <i>Sheldon</i> | | Date Considered <i>7/30/04</i> |

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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